

IN THE CLAIMS:

Please cancel claims 11, 13, 16 and 18 without prejudice or disclaimer, and amend claims 17 and 19 as follows:

1-13. (Cancelled)

14. (Withdrawn) A manufacturing method of a display device being characterized in that the method manufactures a display device which includes a metal heat diffusion member which is superposed on a lower layer of a transparent electrode by way of an insulation film, and the heat diffusion member has a projecting portion at a portion thereof remoter than a distance between the heat diffusion member and the thin film translator, wherein the heat diffusion member is superposed on the transparent electrode at the projecting portion, and the heat diffusion member and the transparent electrode are cut at the projecting portion so as to repair a short-circuit.

15. (Withdrawn) A manufacturing method of a display device according to claim 14, wherein the projecting portion and the transparent electrode are cut by heating the projecting portion with laser beams and, at the same time, the transfer of heat to the thin film transistor at the time of cutting is suppressed by the metal heat diffusion member.

16. (Cancelled)

17. (Currently Amended) ~~[[The]]~~ A liquid crystal display device according to claim 16, further comprising:

thin film transistors, scanning signal lines, data signal lines which are arranged in a state that the data signal lines intersect the scanning signal lines, a pixel electrode electrically connected to an output electrode of one of the thin film transistors, and a common electrode which forms an electric field between the common electrode and the pixel electrode;

a pixel region which is surrounded by neighboring two of the scanning signal lines and neighboring two of the data signal lines;

a metal heat diffusion member disposed in a spaced apart manner from the thin film transistor, the heat diffusion member having a projecting portion which is

remoter than a distance between the thin film transistor and the heat diffusion member;

an electrode residue which short-circuits the pixel electrode and the common electrode as the pixel electrode and the common electrode are formed; and

a laser beam irradiated void on the projecting portion of the heat diffusion member and a simultaneously-formed laser beam irradiated void on the pixel electrode, wherein the voids electrically insulate insulating the pixel electrode from the common electrode after the pixel electrode and the common electrode are short-circuited,

wherein the projecting portion of the heat diffusion member is superposed with a transparent electrode, and the transparent electrode is one of the pixel electrode and the common electrode,

the pixel electrode and the common electrode are formed in the same layer, and

an inorganic insulation film and an organic insulation film are provided between a layer on which the heat diffusion member is formed and the layer in which the pixel electrode and the common electrode are formed, and the organic insulation film has a removed portion at least at the superposed portion between the heat diffusion member and the transparent electrode.

18. (Cancelled)

19. (Currently Amended) ~~[[The]]~~ A display device ~~according to claim 18,~~ further comprising:

a pixel electrode and a common electrode formed in the same layer;

a metal heat diffusion member formed in a layer different from the layer in which the pixel electrode and the common electrode are formed, the heat diffusion member having a projecting portion at a portion thereof remoter than a distance between the heat diffusion member and a thin film transistor;

an electrode residue which short-circuits the pixel electrode and the common electrode as the pixel electrode and the common electrode are formed; and

a laser beam irradiated void on the projecting portion of the heat diffusion member and a simultaneously-formed laser beam irradiated void on the pixel electrode, wherein the voids electrically insulate insulating the pixel electrode from

the common electrode after the pixel electrode and the common electrode are short-circuited,

wherein the heat diffusion member is superposed on the pixel electrode or the common electrode at the projecting portion, and

wherein an inorganic insulation film and an organic insulation film are provided between a layer on which the heat diffusion member is formed and the layer in which the pixel electrode or the common electrode are formed, and the organic insulation film has a removed portion at least at the superposed portion between the heat diffusion member and the pixel electrode or the common electrode.